Bill of Materials

TI DESIGNS

TIDC-WIFI-METER-READING (5VPS)

Item #	Quantity	Designator	Value	Description	Manufacturer	PartNumber	Alternate Part	Footprint	Component Link URL
1	2	C1, C2	6.8uF	CAP, AL, 6.8uF, 400V, +/-20%, TH	Rubycon	400AX6R8M8x11	400AX8.2M8X16	CAPPRD350W60	Rubycon
2				CAP, CERM, 220pF, 630V, +/-5%,					
	1	C3	220pF	U2J, 1206	MuRata	GRM31A7U2J221JW31D		1206	<u>MuRata</u>
3	1	C4	4.7uF	CAP, CERM, 4.7uF, 25V, +/-10%,	MuRata	GRM21BC81E475KA12L		0805_HV	<u>MuRata</u>
4				CAP, TA, 470uF, 10V, +/-10%,					
	1	C5	470uF	0.045 ohm, SMD	AVX	TPSE477K010R0045		7343-43	<u>AVX</u>
5	1	C8	1000pF	CAP, CERM, 1000pF, 50V, +/-5%,	TDK	C1608C0G1H102J		0603	<u>TDK</u>
6				CAP, CERM, 33pF, 1000V, +/-5%,					
	1	C9	33pF	U2J, 1206	MuRata	GRM31A7U3A330JW31D		1206	MuRata
7	1	D1	600V	Diode, Switching-Bridge, 100V,	Fairchild	MB6S		TO-269AA	Semiconductor
8				Diode, Switching, 200V, 0.2A, SOD-					
	1	D2	200V	123	Diodes Inc.	BAV21W-7-F		SOD-123	Diodes Inc.
9	1	D3	600V	Diode, Superfast Rectifier, 600V,	Diodes Inc.	DFLR1600		powerDI123	Diodes Inc.
10				Diode, Schottky, 40V, 10A,					
	1	D4	40V	PowerDI5	Diodes Inc.	PDS1040L-13		PowerDI5	Diodes Inc.
11	1	FB1	600 ohm	2A Ferrite Bead, 600 ohm @	TDK	MPZ2012S601A		0805_HV	<u>TDK</u>
12				Inductor, Unshielded Drum Core,					
				Ferrite, 470uH, 0.35A, 1.58 ohm,	Wurth Elektronik				Wurth Elektronik
	1	L1	470uH	тн	eiSos	7447462471		IND_WE-TI_XS	eiSos
13	1	R1	300k	RES, 300k ohm, 1%, 0.25W, 1206	Yageo America	RC1206FR-07300KL		1206	Yageo America
14	1	R2	300	RES, 300 ohm, 1%, 0.25W, 1206	Yageo America	RC1206FR-07300RL		1206	Yageo America
15	1	R4	22	RES, 22 ohm, 5%, 0.1W, 0603	Vishay-Dale	CRCW060322R0JNEA		0603	Vishay-Dale
16	1	R5	1.3k	RES, 1.3k ohm, 5%, 0.1W, 0603	Yageo America	RC0603JR-071K3L		0603	Yageo America
17	1	R6	36k	RES, 36k ohm, 5%, 0.1W, 0603	Vishay-Dale	CRCW060336K0JNEA		0603	Vishay-Dale
18	1	R7	910k	RES, 910k ohm, 5%, 0.1W, 0603	Vishay-Dale	CRCW0603910KJNEA		0603	Vishay-Dale
19	1	R8	62k	RES, 62k ohm, 5%, 0.125W, 0805	Vishay-Dale	CRCW080562K0JNEA		0805	Vishay-Dale
20	1	R9	15	RES, 15 ohm, 5%, 0.125W, 0805	Panasonic	ERJ-6GEYJ150V		0805_HV	Panasonic
21	1	R10	3.9k	RES, 3.9k ohm, 5%, 0.1W, 0603	Yageo America	RC0603JR-073K9L		0603	Yageo America
22									<u>WURTH</u>
	1	T1		Transformer	WURTH ELEKTRONIK	750841012		D00074 N	ELEKTRONIK
23	1	U1		LOW STAND-BY POWER, CV / CC	Texas Instruments	UCC28910D		D0007A_N	<u>i exas instruments</u>

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